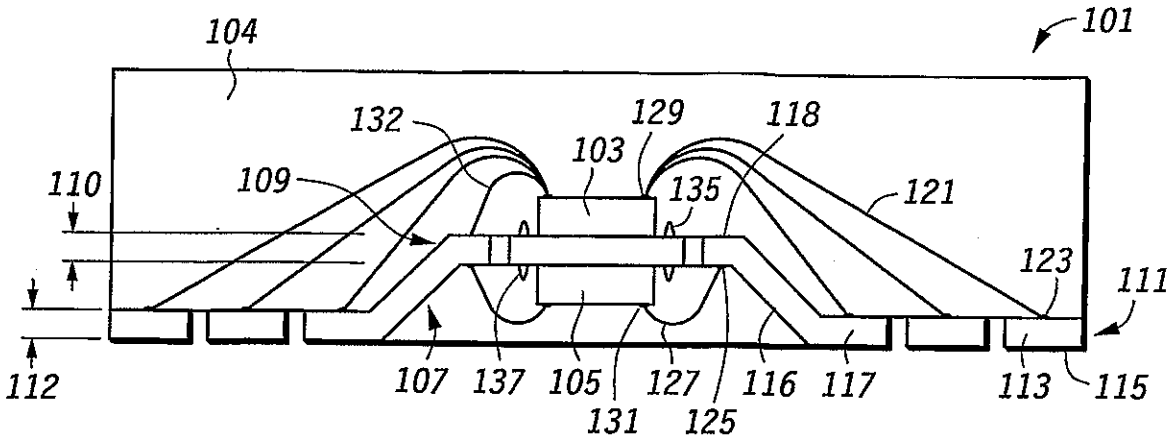

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FIG.1

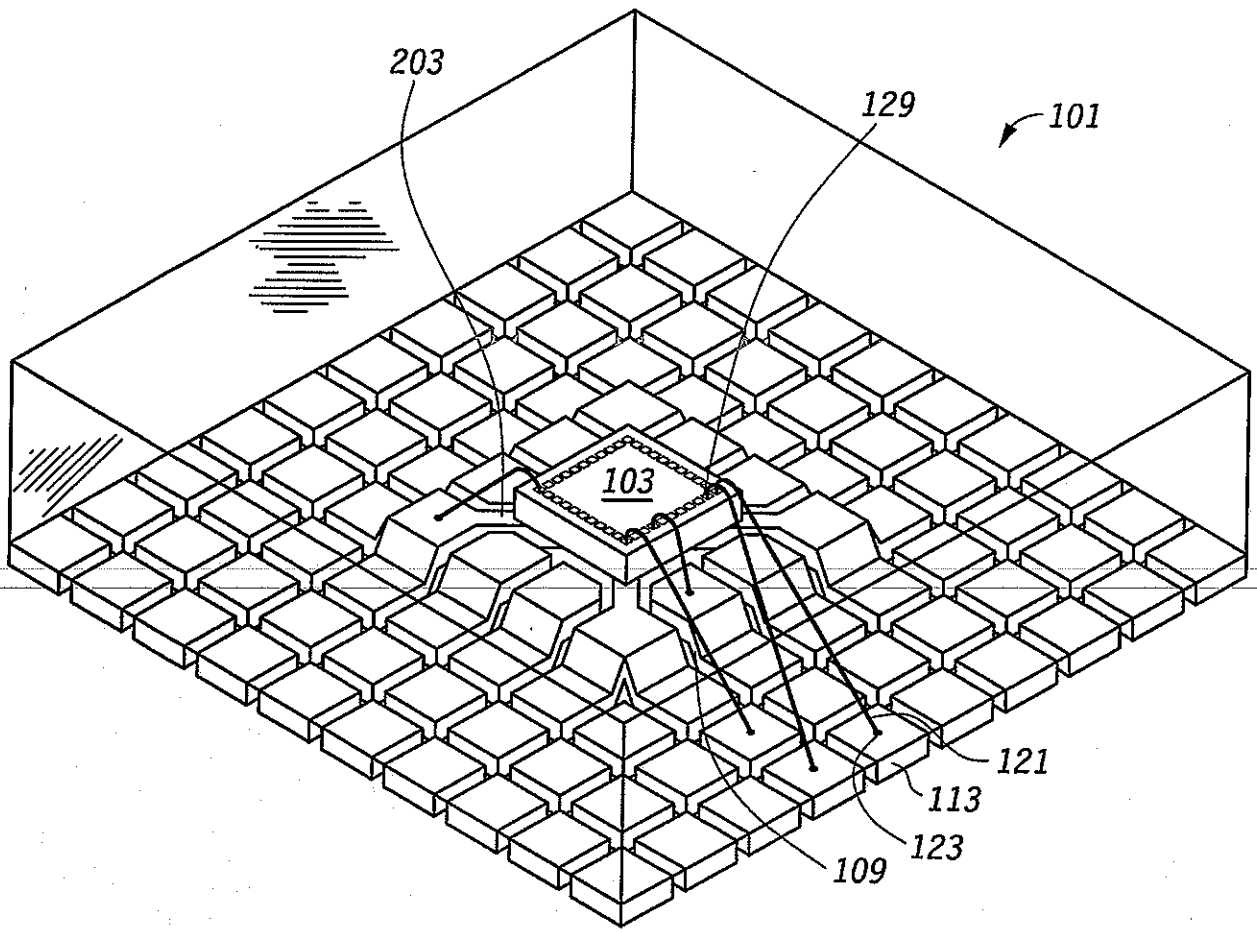

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FIG.2

FIG.3

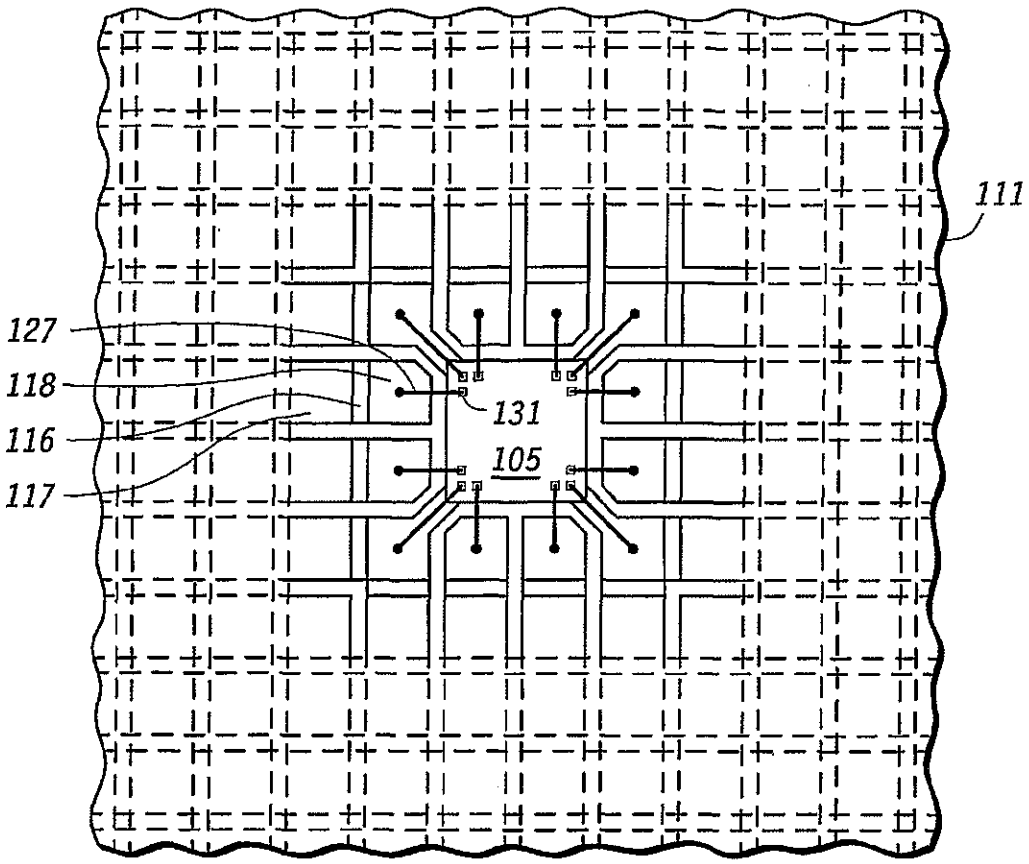


FIG.4

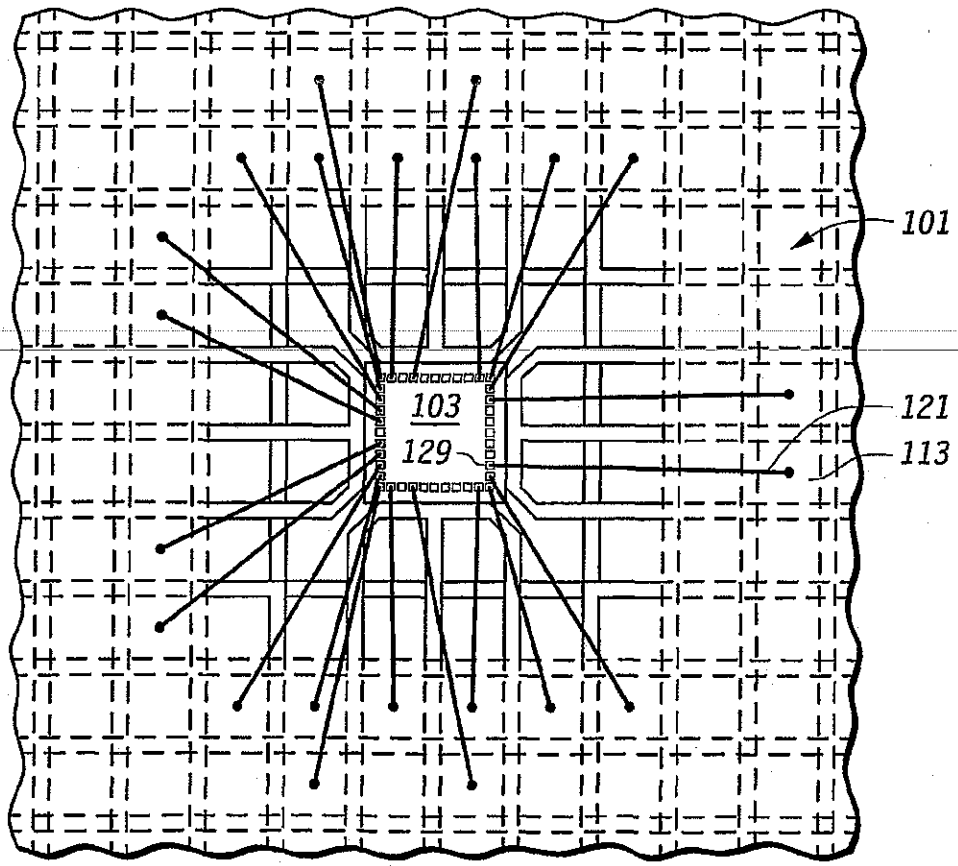
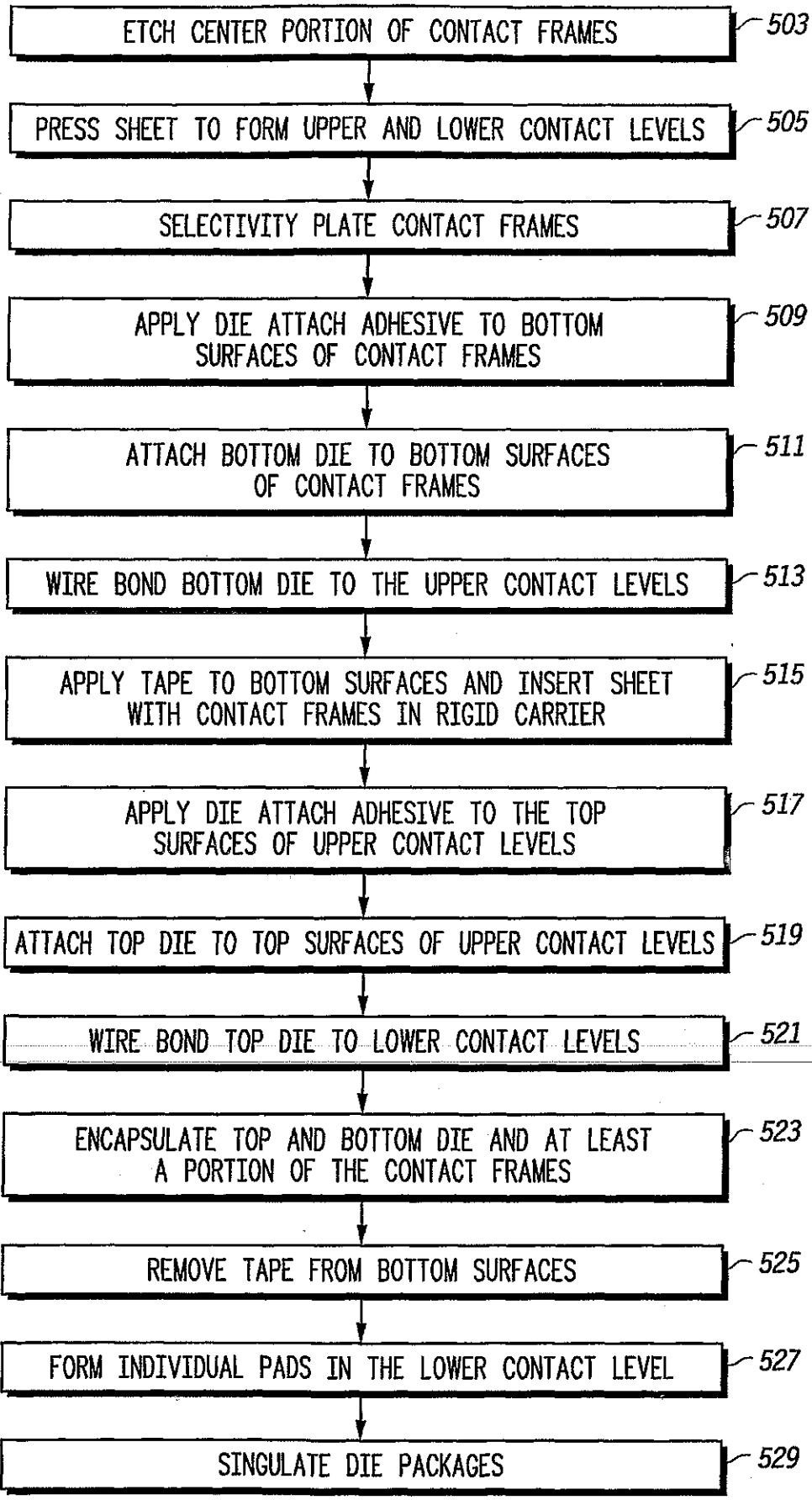


FIG.5


ETCH CENTER PORTION OF CONTACT FRAMES
503
PRESS SHEET TO FORM UPPER AND LOWER CONTACT LEVELS
505
SELECTIVITY PLATE CONTACT FRAMES
507
APPLY DIE ATTACH ADHESIVE TO BOTTOM SURFACES OF CONTACT FRAMES
509
ATTACH BOTTOM DIE TO BOTTOM SURFACES OF CONTACT FRAMES
511
WIRE BOND BOTTOM DIE TO THE UPPER CONTACT LEVELS
513
APPLY TAPE TO BOTTOM SURFACES AND INSERT SHEET WITH CONTACT FRAMES IN RIGID CARRIER
515
APPLY DIE ATTACH ADHESIVE TO THE TOP SURFACES OF UPPER CONTACT LEVELS
517
ATTACH TOP DIE TO TOP SURFACES OF UPPER CONTACT LEVELS
519
WIRE BOND TOP DIE TO LOWER CONTACT LEVELS
521
ENCAPSULATE TOP AND BOTTOM DIE AND AT LEAST A PORTION OF THE CONTACT FRAMES
523
REMOVE TAPE FROM BOTTOM SURFACES
525
FORM INDIVIDUAL PADS IN THE LOWER CONTACT LEVEL
527
SINGULATE DIE PACKAGES
529